
SPECIFICATION

Ceramic Antenna 2012 Size

P/N: HXD-BT05S

Manufacturer: Shenzhen Chaoyasi Electronics Co., Ltd.

Address: Room 203, No.134, Sanhe New Second Village, Huarong Community, Dalang Street,
Longhua District, Shenzhen, China

1. Frequency

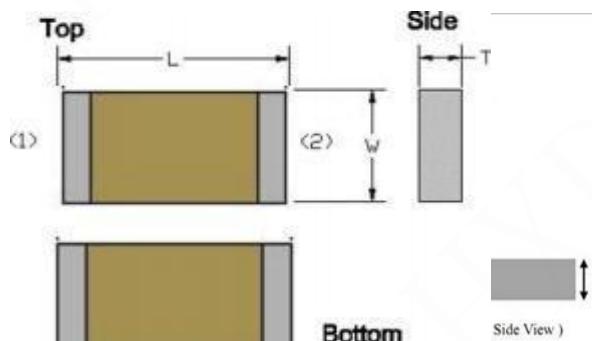
2400-2500 MHz

2. Applications

For Miniaturized Bluetooth System

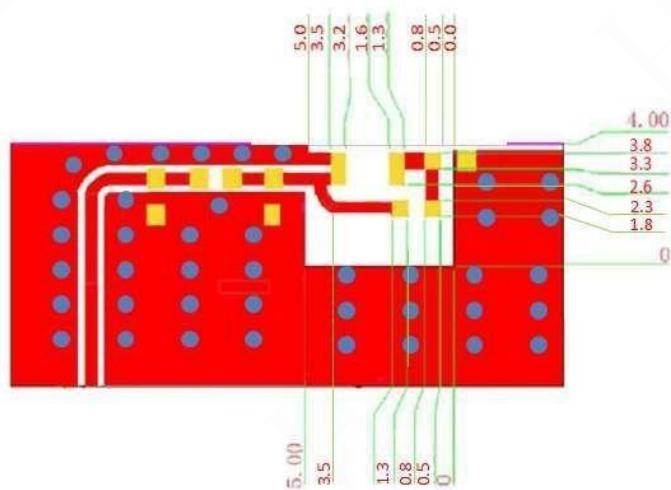
3. Dimensions (Unit : mm)

1). Over View :

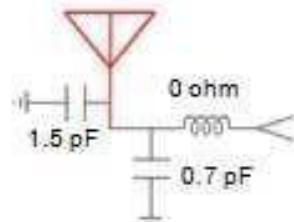
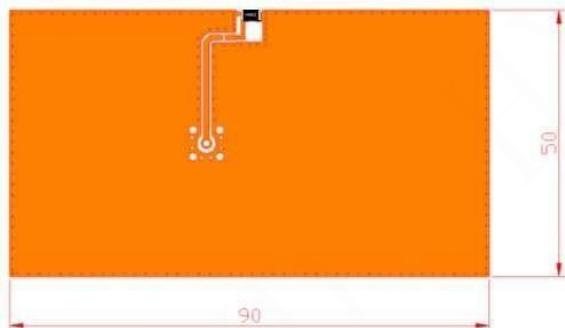


Symbols	L	W	T	A
Dimensions	2.0 ⁺ /-0.2	1.2 ⁺ /-0.2	0.5 ⁺ /-0.1	0.3 ⁺ /-0.2

2). PCB Layout (Unit : mm):



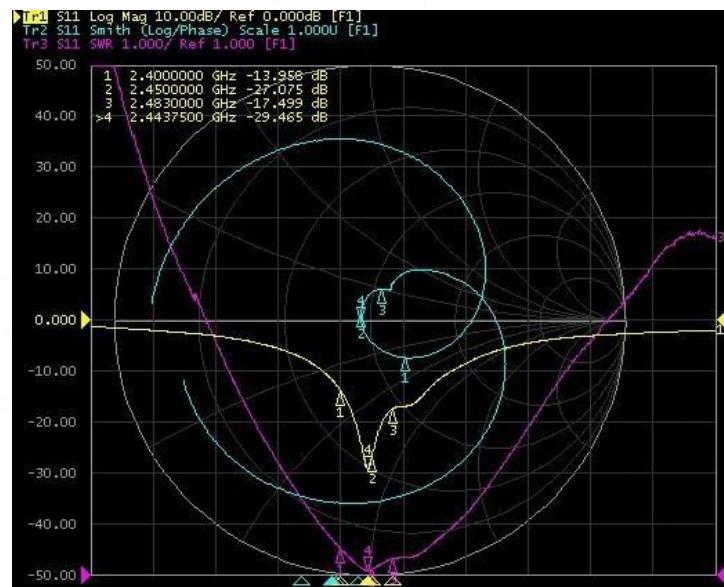
4. Evaluation Board Size and Matching Circuits



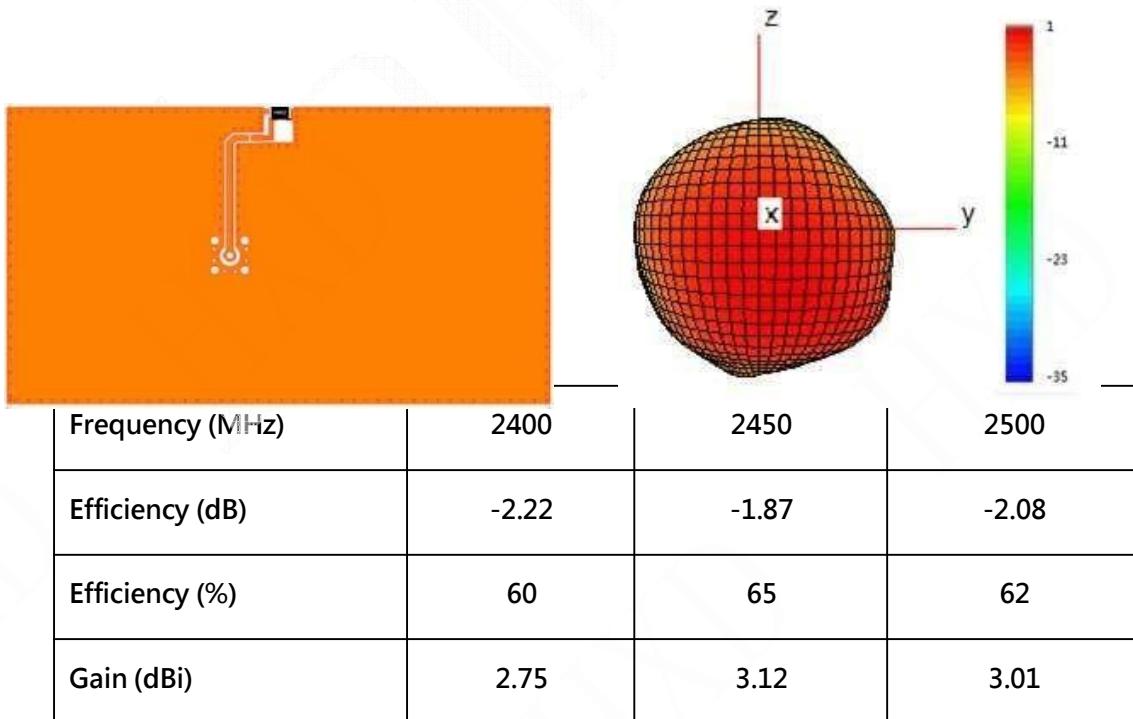
5. Electrical Characteristics

Part Number	HXD-BT05S
Central Frequency	2450 MHz
Bandwidth	100(typ.) MHz
V.S.W.R	≤ 2.0
Peak Gain	3.12 dBi
Impedance	50 Ohm
Polarization	Linear
Azimuth Beamwidth	Omni-directional

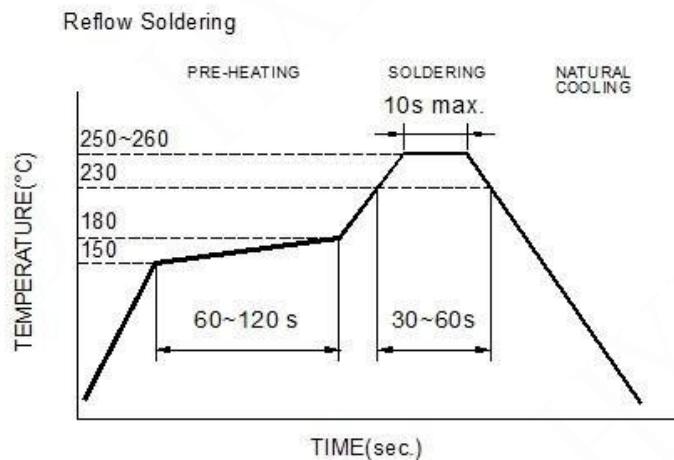
6. Return Loss (S11)



7. Radiation Pattern & Efficiency

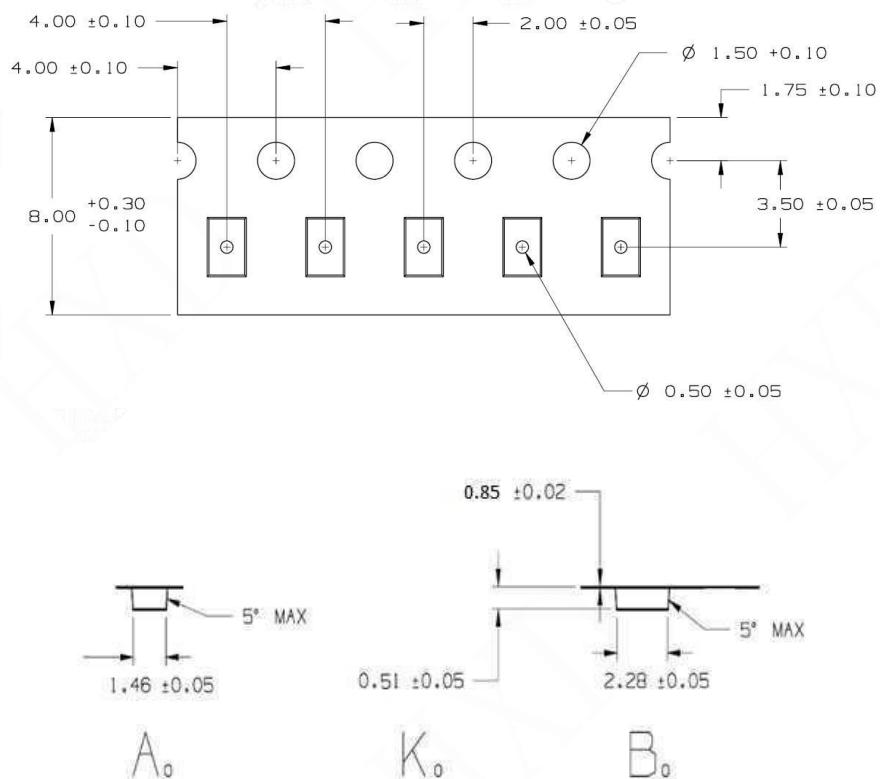


8. Reflow Soldering Standard Condition



9. Packaging and Dimensions

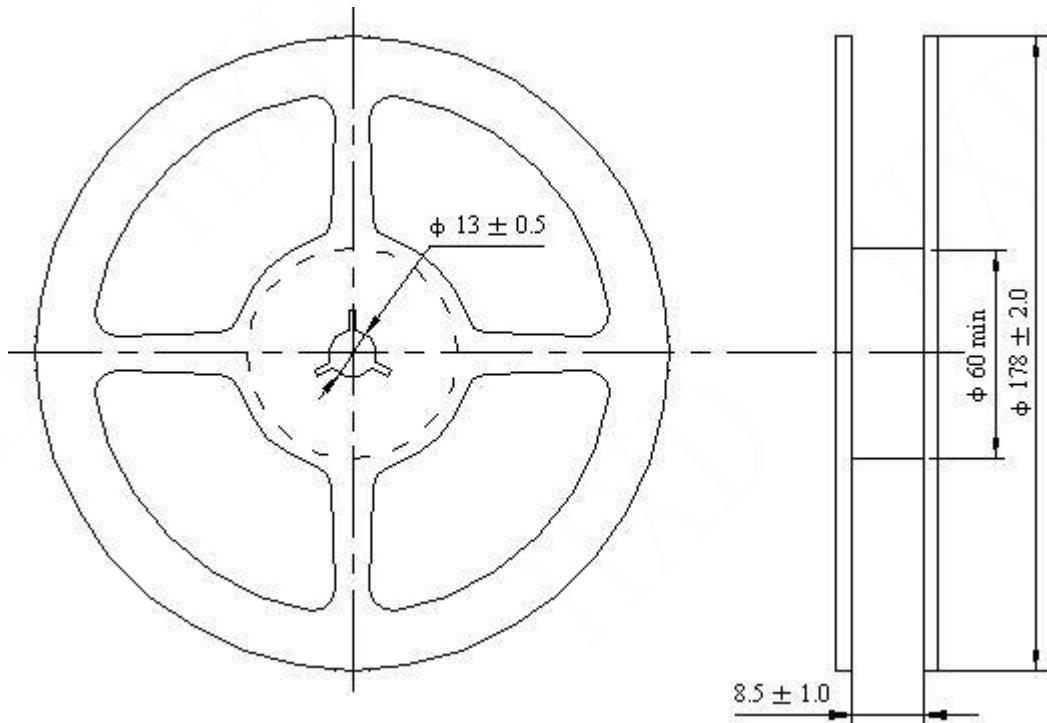
- Plastic Tape



- **Remarks for Package**

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

- **Reel (4000 pcs/Reel)**



Storage Period

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH

10. Dependability Test

Test item	Test condition / Test method	Specification
Solderability IEC 60068-2-58 GB/T2423.28	*Solder bath temperature: 240±5°C *Immersion time: 2±0.5 sec Solder: Sn96.5Ag3.0Gu0.5 for lead-free.	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature: 260±5°C *Leaching immersion time: 10±1 sec Solder : Sn96.5 Ag3.0 Gu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature: 120~150°C, 1 minute. *Solder temperature: 260±5°C *Immersion time: 10±1 sec Solder: Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test IEC 60068-2-32 GB/T2423.8 Customer' s specification.	*Height: 50 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Vibration IEC 60068-2-6 GB/T 2423.10	*Frequency: 10Hz~55Hz~10Hz(1min) *Total amplitude: 1.5mm *Test times: 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force: 5N(≤0603); 10N(>0603) *Test time:10±1 sec	No remarkable damage or removal of the termination.

Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10 ± 1 sec. Measurement to be made after keeping at room temperature for 24 ± 2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC 60068-2-14 GB/T 2423.22	30 minutes at $-40^{\circ}\text{C}\pm 2^{\circ}\text{C}$. 10~15 minutes at room temperature. 30 minutes at $+85^{\circ}\text{C}\pm 2^{\circ}\text{C}$. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T 2423.2	*Temperature: $85\pm 2^{\circ}\text{C}$. *Test duration: 500+24/-0 hours. Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC 60068-2-3 GB/T 2423.3	*Humidity: $85\pm 5\%$ R.H. *Temperature: $85\pm 2^{\circ}\text{C}$. *Time: 500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24 ± 2 hrs ※ 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T 2423.1	*Temperature: $-40\pm 2^{\circ}\text{C}$. *Test duration: 500+24/-0 hours Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.